EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

# **Technical Data Sheet**

# 0603 Package Chip LED (0.8mm Height)

# 19-21/BHC-YL1M1RY/3T

### Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow

solder process.

- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version

### Descriptions

- The 19-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Indoor signboard use.

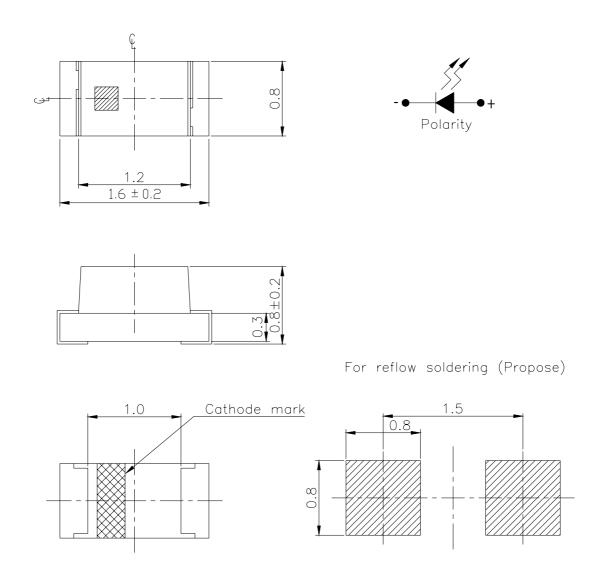
### **Device Selection Guide**

Part No.			
	Material	<b>Emitted</b> Color	Lens Color
19-21/BHC-YL1M1RY/3T	InGaN	Blue	Water Clear





## **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm, Unit = mm

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## 19-21/BHC-YL1M1RY/3T

### Absolute Maximum Ratings (Ta=25°C)

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The solute maximum rannings (Tu-20 C)						
Parameter	Symbol	Rating	Unit			
Reverse Voltage	VR	5	V			
Forward Current	IF	25	mA			
Operating Temperature	Topr	-40 ~ +85	°C			
Storage Temperature	Tstg	-40 ~ +90	°C			
Electrostatic Discharge(HBM)	ESD	150	V			
Power Dissipation	Pd	110	mW			
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA			
Soldering Temperature	Tsol	Reflow Soldering : $260 \degree C$ for 10 sec. Hand Soldering : $350 \degree C$ for 3 sec.				

### Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_V$	11.5		22.5	mcd	
Peak Wavelength	λp		468		nm	
Dominant Wavelength	λd	470.0		475.0	nm	
Spectrum Radiation Bandwidth	$ riangle \lambda$		20		nm	I <sub>F</sub> =5mA
Viewing Angle	$2 \theta 1/2$		100		deg	
Forward Voltage	$V_{\rm F}$	2.50		3.10	V	
Reverse Current	I <sub>R</sub>			50	$\mu A$	V <sub>R</sub> =5V

### Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.05V

Bin Range Of Dom. Wavelength								
Group	Bin	Min	Min Max		Unit		Condition	
Y	Y	470.0	470.0 475.0		nm		I <sub>F</sub> =5mA	
Bin Range Of	Bin Range Of Luminous Intensity							
Bin	Min	М	ax	Unit		Condition		
L1	11.5	14	.5					
L2	14.5	18	.0		mcd		I <sub>F</sub> =5mA	
M1	18.0	22	.5					
	I	I		1				

### **Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition	
	9	2.50	2.70			
R	10	2.70	2.90	V	IF=5mA	
	11	2.90	3.10			

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

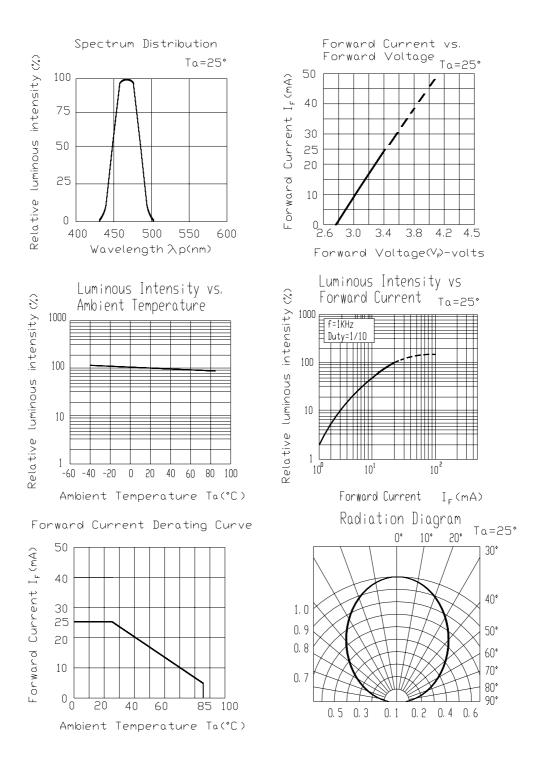
3.Tolerance of Forward Voltage ±0.05V

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### 19-21/BHC-YL1M1RY/3T

### **Typical Electro-Optical Characteristics Curves**

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## 19-21/BHC-YL1M1RY/3T

### Label explanation

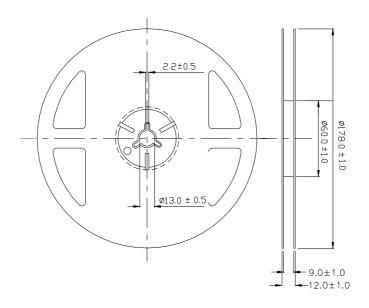
**CAT: Luminous Intensity Rank** 

HUE: Dom. Wavelength Rank

**REF: Forward Voltage Rank** 



### **Reel Dimensions**

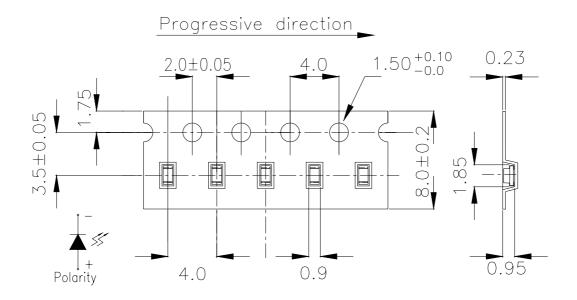


**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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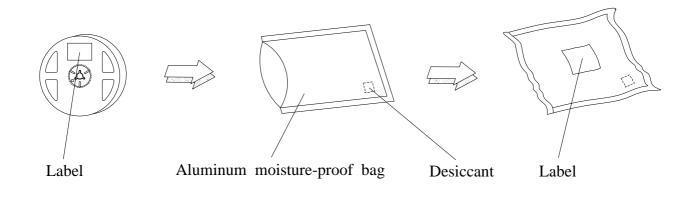
### 19-21/BHC-YL1M1RY/3T

### **Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel**



**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm ,Unit = mm

### **Moisture Resistant Packaging**



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## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

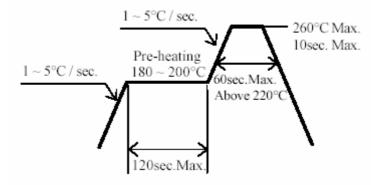
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min $\int 5 \text{ min}$ L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	<b>Temp.</b> : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20  mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



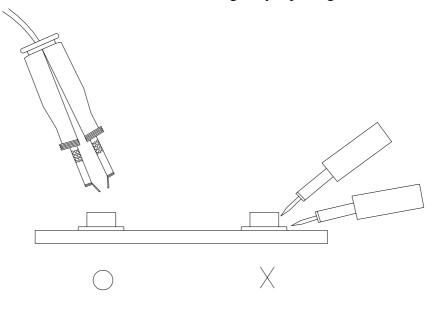
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

### 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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